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Stocking Distributor

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ON Semiconductor 2N6400

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2N6400 Series

Preferred Device

Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls and power supplies; or wherever half-wave silicon gate-controlled, solid-state devices are needed.

- Glass Passivated Junctions with Center Gate Geometry for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Blocking Voltage to 800 Volts
- Device Marking: Logo, Device Type, e.g., 2N6400, Date Code

*MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)						
Rating	Symbol	Value	Unit			
Peak Repetitive Off–State Voltage (Note 1.) $(T_J = -40 \text{ to } 125^{\circ}\text{C}$, Sine Wave 50 to 60 Hz; Gate Open)	V _{drm,} V _{rrm}		Volts			
2N6400 2N6401 2N6402 2N6403 2N6404 2N6405		50 100 200 400 600 800				
On-State RMS Current (180° Conduction Angles; T _C = 100°C)	I _{T(RMS)}	16	A			
Average On-State Current (180° Conduction Angles; T _C = 100°C)	I _{T(AV)}	10	A			
Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, T _J = 90°C)	I _{TSM}	160	A			
Circuit Fusing (t = 8.3 ms)	l ² t	145	A ² s			
Forward Peak Gate Power (Pulse Width \leq 1.0 μ s, T _C = 100°C)	P _{GM}	20	Watts			
Forward Average Gate Power (t = 8.3 ms, T _C = 100°C)	$P_{G(AV)}$	0.5	Watts			
Forward Peak Gate Current (Pulse Width \leq 1.0 μ s, T _C = 100°C)	I _{GM}	2.0	A			
Operating Junction Temperature Range	TJ	-40 to +125	°C			
Storage Temperature Range	T _{stg}	–40 to +150	°C			

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*Indicates JEDEC Registered Data.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

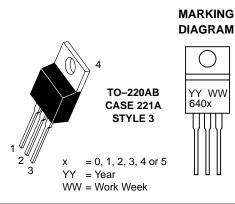


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SCRs **16 AMPERES RMS** 50 thru 800 VOLTS





	PIN ASSIGNMENT
1	Cathode
2	Anode
3	Gate
4	Anode

ORDERING INFORMATION

Device	Package	Shipping
2N6400	TO220AB	500/Box
2N6401	TO220AB	500/Box
2N6402	TO220AB	500/Box
2N6403	TO220AB	500/Box
2N6404	TO220AB	500/Box
2N6405	TO220AB	500/Box

Preferred devices are recommended choices for future use and best overall value.



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	ΤL	260	°C

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted.)

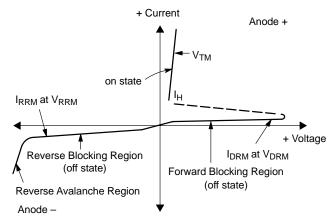
Characteristic	Symbol	Min	Тур	Max	Unit		
OFF CHARACTERISTICS							
*Peak Repetitive Forward or Reverse Blocking C (V _{AK} = Rated V _{DRM} or V _{RRM} , Gate Open)	urrent T _J = 25°C T _J = 125°C	I _{DRM} , I _{RRM}			10 2.0	μA mA	
ON CHARACTERISTICS							
*Peak Forward On–State Voltage (I_{TM} = 32 A Peak, Pulse Width \leq 1 ms, Duty Cycle \leq 2%)		V _{TM}	-	-	1.7	Volts	
*Gate Trigger Current (Continuous dc) ($V_D = 12$ Vdc, $R_L = 100$ Ohms)	$T_{C} = 25^{\circ}C$ $T_{C} = -40^{\circ}C$	I _{GT}		9.0 _	30 60	mA	
*Gate Trigger Voltage (Continuous dc) (V _D = 12 Vdc, R _L = 100 Ohms)	T _C = 25°C T _C = -40°C	V _{GT}		0.7	1.5 2.5	Volts	
Gate Non–Trigger Voltage (V _D = 12 Vdc, R _L = 100 Ohms)	T _C = +125°C	V _{GD}	0.2	_	_	Volts	
*Holding Current (V _D = 12 Vdc, Initiating Current = 200 mA, Gate Open)	$T_{C} = 25^{\circ}C$ $*T_{C} = -40^{\circ}C$	Ι _Η		18 -	40 60	mA	
Turn-On Time $(I_{TM} = 16 \text{ A}, I_{GT} = 40 \text{ mAdc}, V_D = \text{Rated } V_{DRM}$)	t _{gt}	-	1.0	-	μs	
Turn-Off Time ($I_{TM} = 16 \text{ A}, I_R = 16 \text{ A}, V_D = \text{Rated } V_{DRM}$)	T _C = 25°C T _J = +125°C	tq		15 35	_ _	μs	
DYNAMIC CHARACTERISTICS							
Critical Rate–of–Rise of Off-State Voltage $(V_D = Rated V_{DRM}, Exponential Waveform)$	T _J = +125°C	dv/dt	-	50	-	V/µs	

*Indicates JEDEC Registered Data.



Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Off State Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Peak On State Voltage
I _H	Holding Current



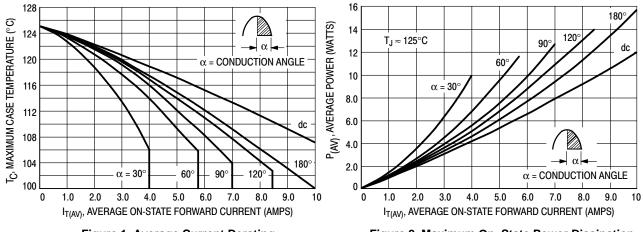
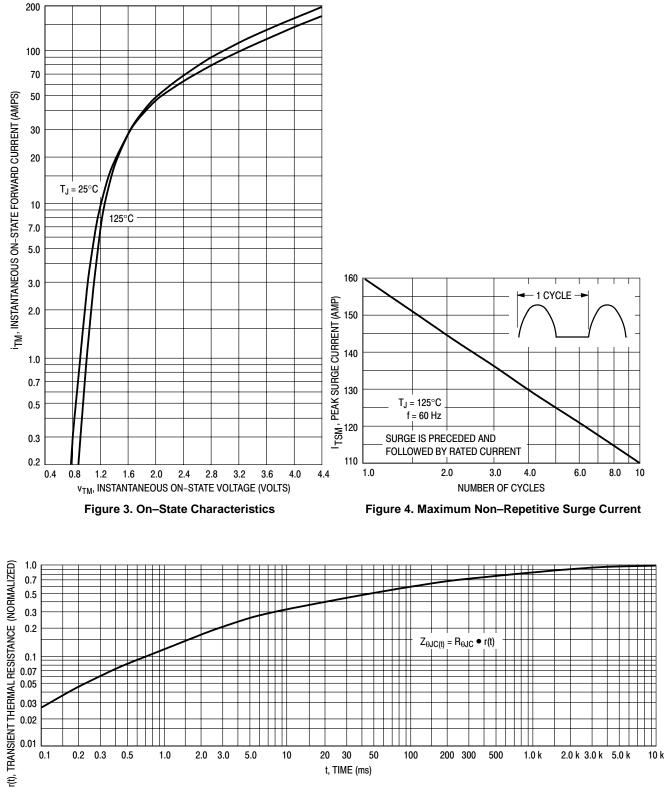


Figure 1. Average Current Derating

Figure 2. Maximum On–State Power Dissipation



2N6400 Series

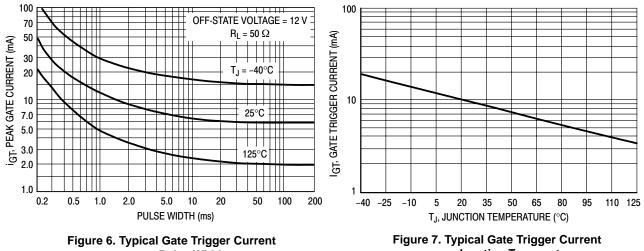






2N6400 Series

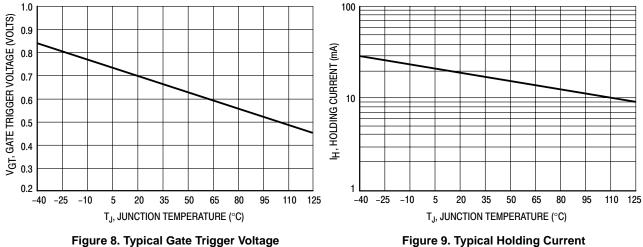
TYPICAL CHARACTERISTICS







versus Junction Temperature

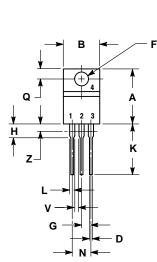


versus Junction Temperature



PACKAGE DIMENSIONS

TO-220AB





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NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION 2 DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
c	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
L	0.014	0.022	0.36	0.55
Κ	0.500	0.562	12.70	14.27
Г	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
υ	0.000	0.050	0.00	1.27
۷	0.045		1.15	
Z		0.080		2.04

STYLE 3: PIN 1. CATHODE ANODE GATE ANODE 2. 3. 4.

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2N6400 Series

<u>Notes</u>



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